/ Descriptions

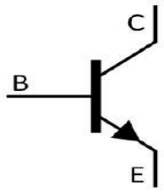
SOT-23 NPN

/ Features

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/ Applications

/ Equivalent Circuit



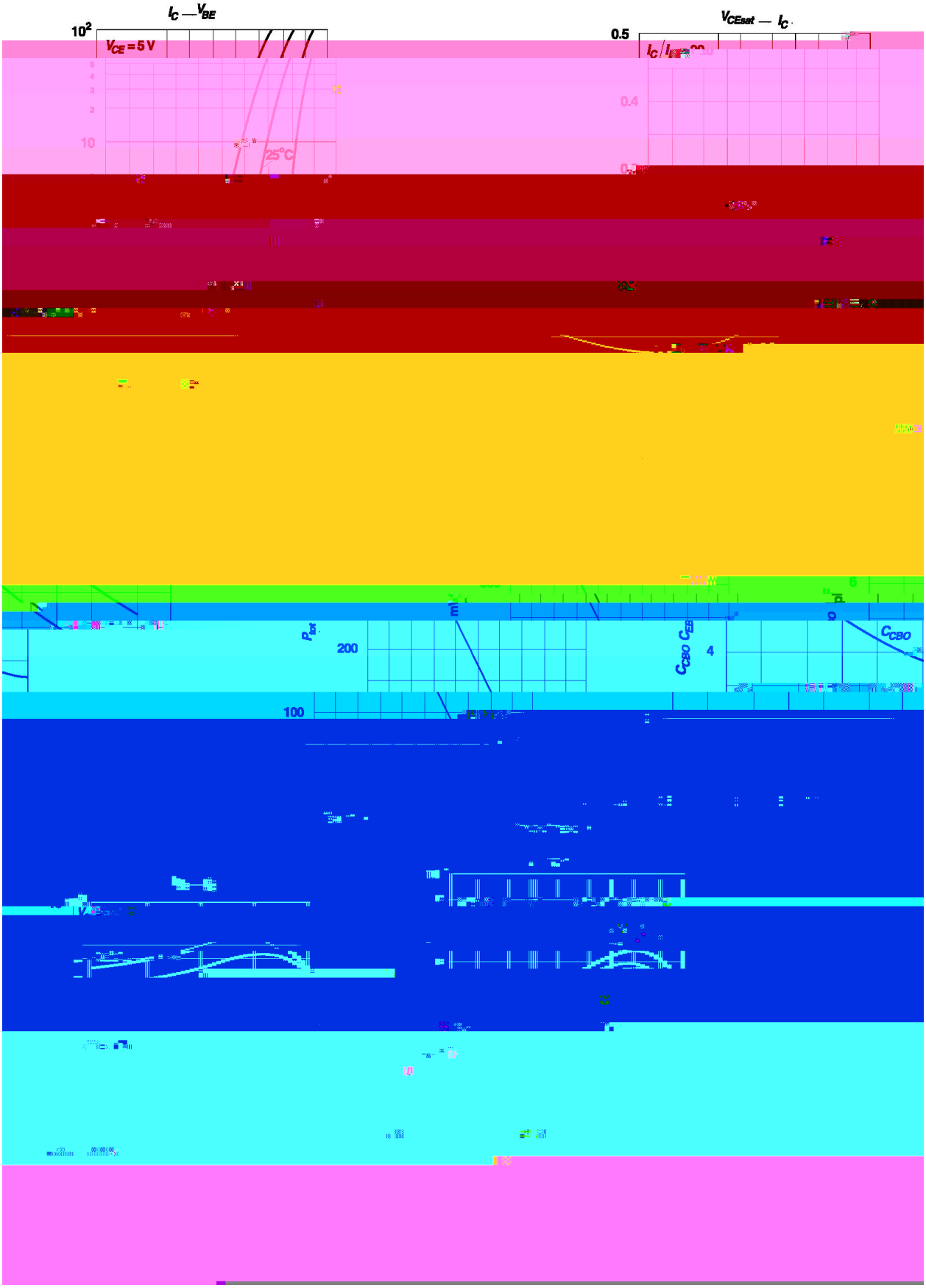
/ Pinning



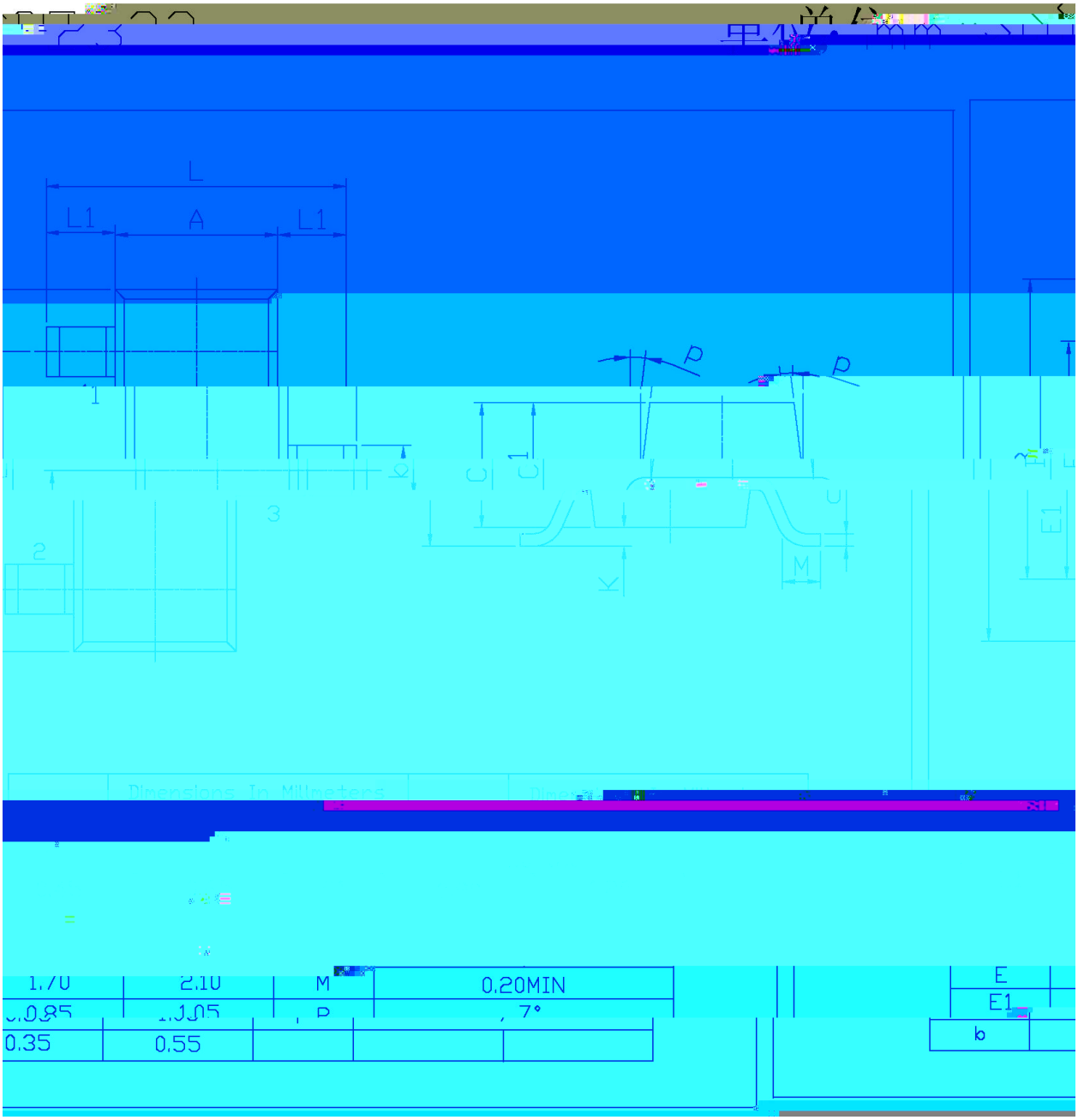
/ h_{FE} Classifications & Marking

Symbol

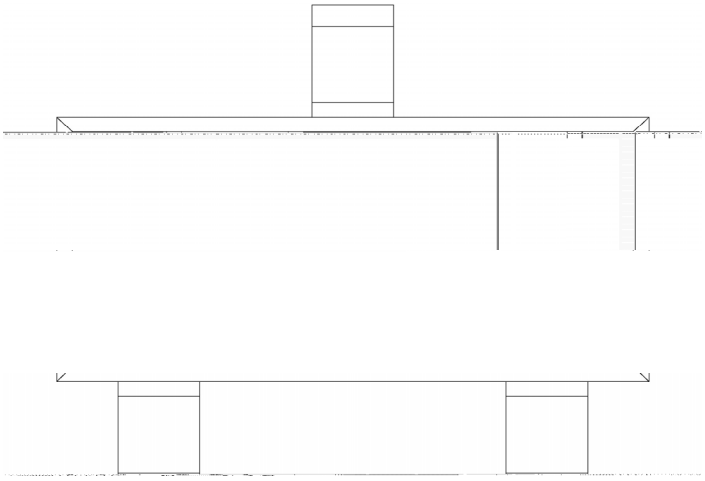
/ Electrical Characteristic Curve



/ Package Dimensions



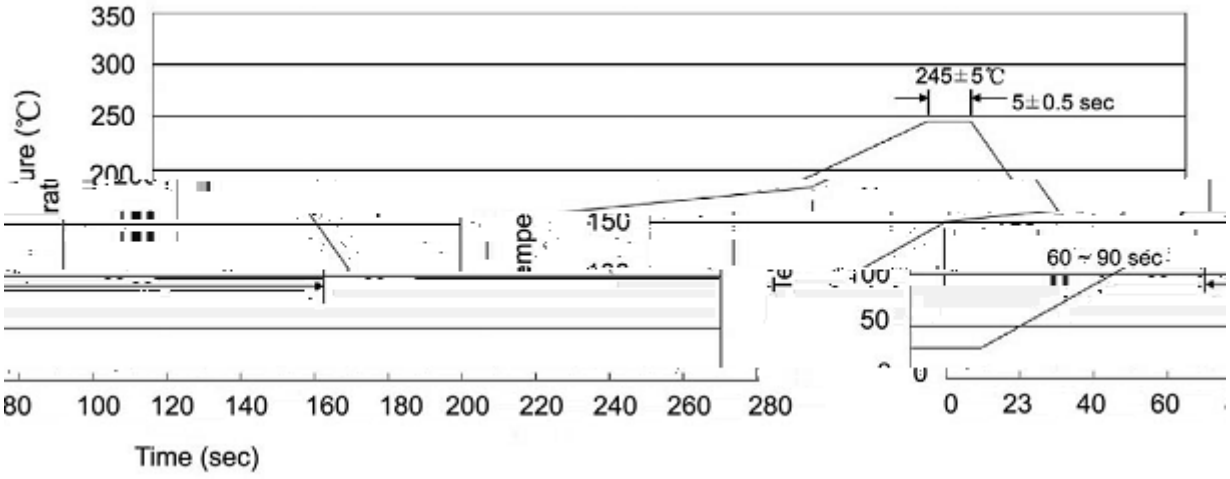
/ Marking Instructions



1A

G

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

/ Notices